



SamHop Microelectronics Corp.



SP2700

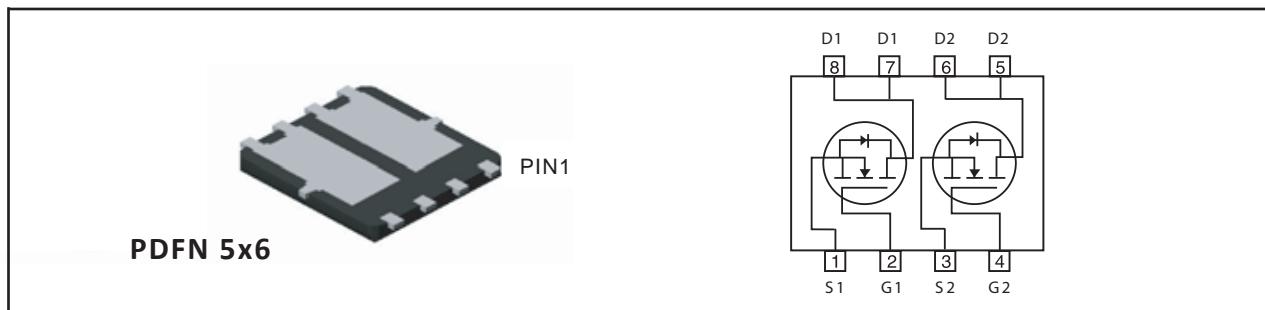
Ver 1.0

Dual N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
75V	2.5A	210 @ VGS=10V
		250 @ VGS=4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
V_{DS}	Drain-Source Voltage		75	V
V_{GS}	Gate-Source Voltage		± 20	V
I_D	Drain Current-Continuous ^c	$T_A=25^\circ\text{C}$	2.5	A
		$T_A=70^\circ\text{C}$	2.0	A
I_{DM}	-Pulsed ^{a,c}		10	A
E_{AS}	Single Pulse Avalanche Energy ^d		16	mJ
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	2.5	W
		$T_A=70^\circ\text{C}$	1.6	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	50	$^\circ\text{C/W}$
-----------------	---	----	--------------------

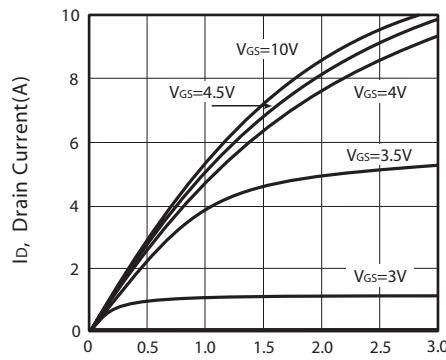
SP2700

Ver 1.0

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

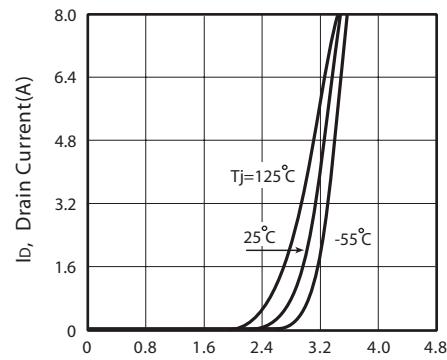
Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BVDSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	75			V
Idss	Zero Gate Voltage Drain Current	$V_{DS}=60V, V_{GS}=0V$			1	μA
IGSS	Gate-Body Leakage Current	$V_{GS} = \pm 20V, V_{DS}=0V$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	2	3	V
RDS(ON)	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=1.25A$		178	210	m ohm
		$V_{GS}=4.5V, I_D=1.15A$		195	250	m ohm
g _{FS}	Forward Transconductance	$V_{DS}=10V, I_D=1.25A$		5.3		S
DYNAMIC CHARACTERISTICS ^b						
C _{ISS}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		480		pF
C _{OSS}	Output Capacitance			28		pF
C _{RSS}	Reverse Transfer Capacitance			22		pF
SWITCHING CHARACTERISTICS ^b						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=37.5V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		11.5		ns
t _r	Rise Time			10.7		ns
t _{D(OFF)}	Turn-Off Delay Time			19		ns
t _f	Fall Time			7.8		ns
Q _g	Total Gate Charge	$V_{DS}=37.5V, I_D=1.25A, V_{GS}=10V$		7.8		nC
		$V_{DS}=37.5V, I_D=1.25A, V_{GS}=4.5V$		4		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=37.5V, I_D=1.25A,$ $V_{GS}=10V$		1.2		nC
Q _{gd}	Gate-Drain Charge			2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=1A$		0.81	1.2	V
Notes						
a.Pulse Test:Pulse Width < 10us, Duty Cycle < 1%.						
b.Guaranteed by design, not subject to production testing.						
c.Drain current limited by maximum junction temperature.						
d.Starting $T_J=25^\circ C, L=0.5mH, V_{DD} = 40V$. (See Figure13)						
e.Mounted on FR4 Board of 1 inch ² , 2oz.						

Jun,19,2014



V_{DS}, Drain-to-Source Voltage(V)

Figure 1. Output Characteristics



V_{Gs}, Gate-to-Source Voltage(V)

Figure 2. Transfer Characteristics

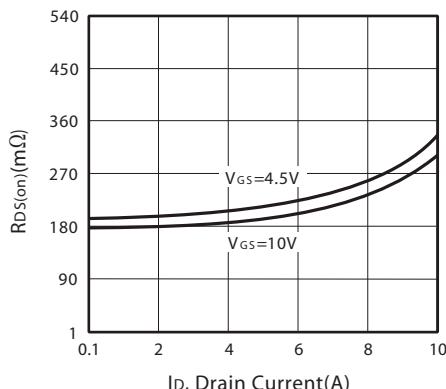


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

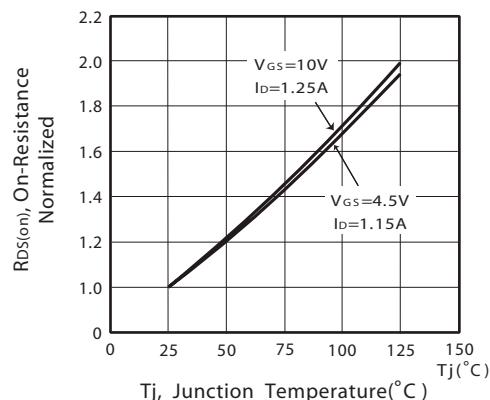


Figure 4. On-Resistance Variation with Drain Current and Temperature

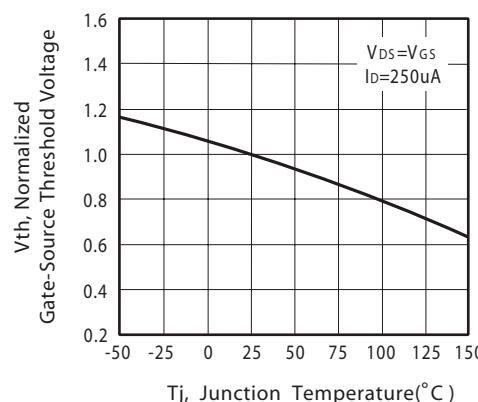


Figure 5. Gate Threshold Variation with Temperature

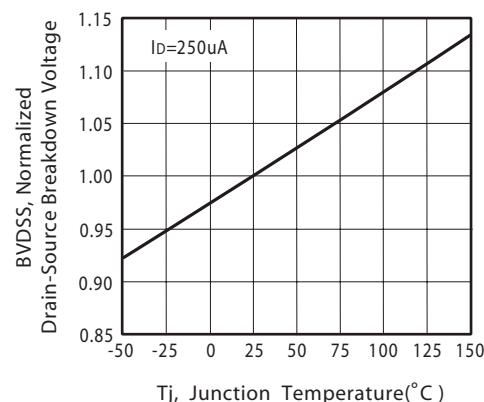
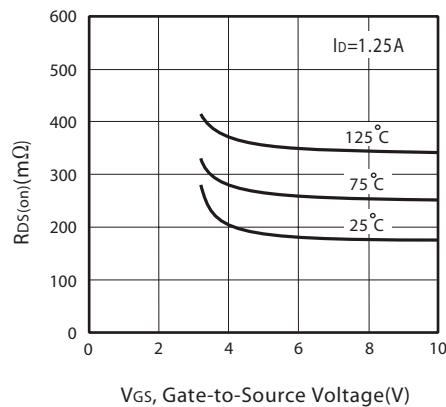


Figure 6. Breakdown Voltage Variation with Temperature

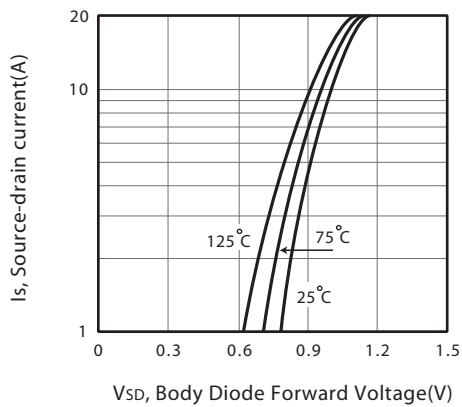
SP2700

Ver 1.0



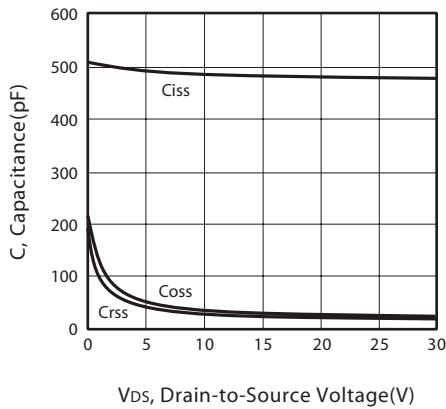
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs.
Gate-Source Voltage



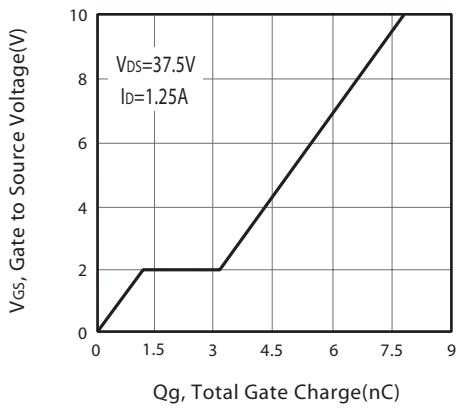
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage
Variation with Source Current



V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q_g, Total Gate Charge(nC)

Figure 10. Gate Charge

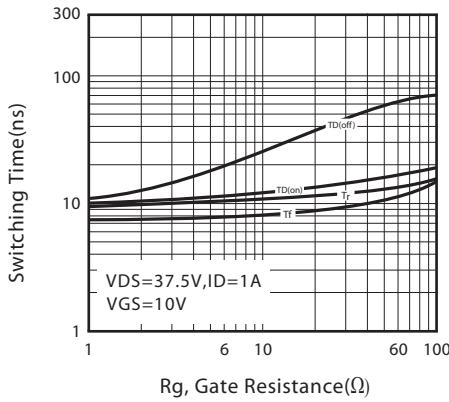


Figure 11. switching characteristics

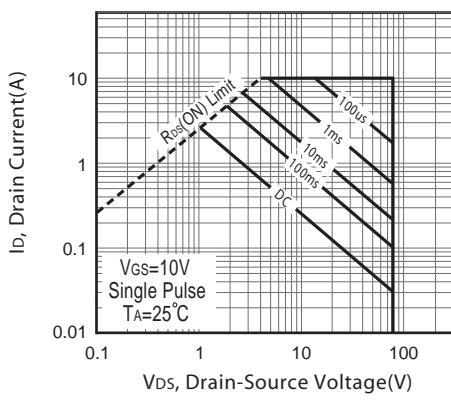
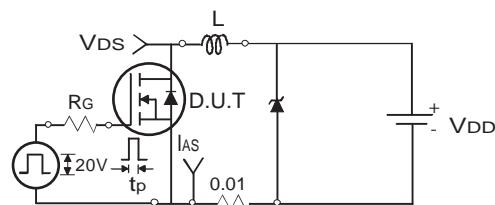
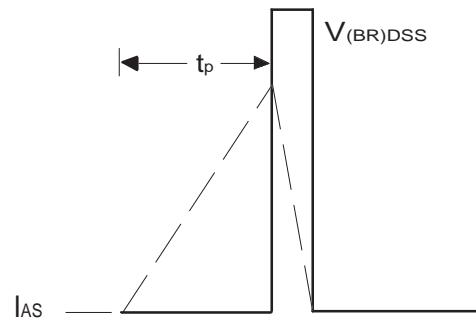


Figure 12. Maximum Safe Operating Area



Uncamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

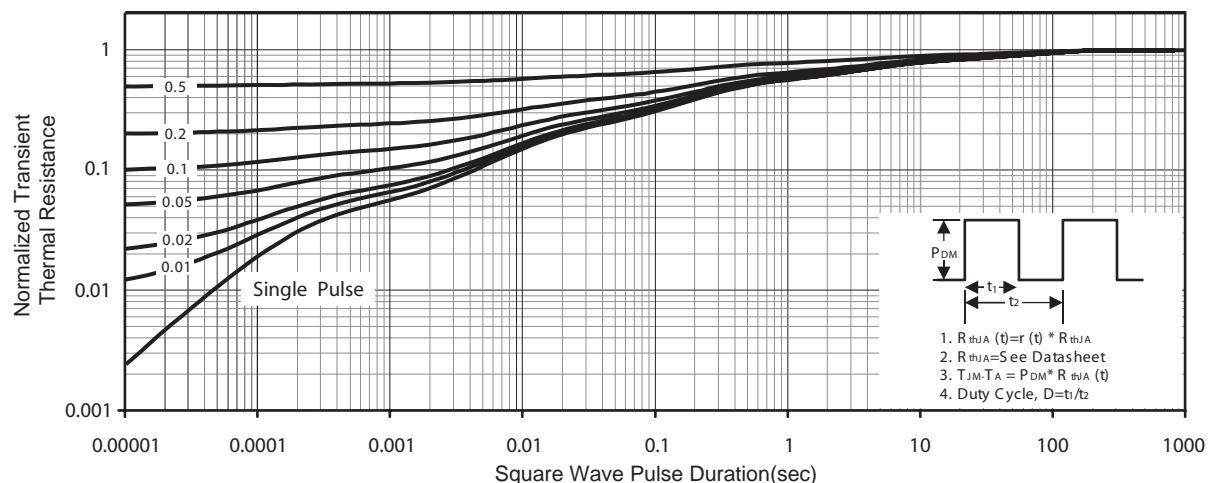
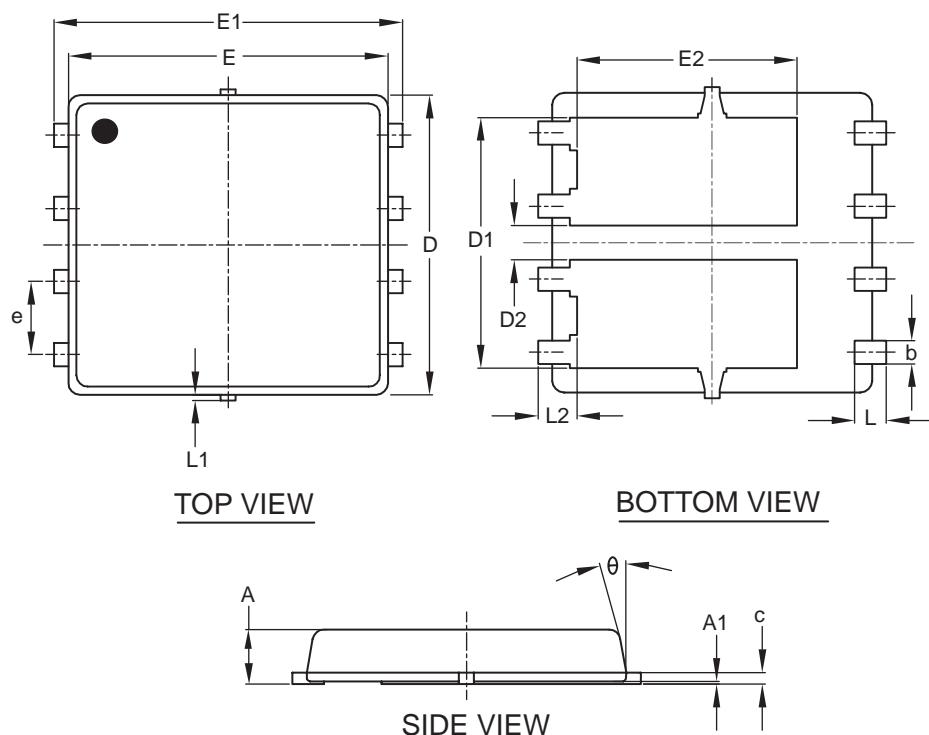


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

PDFN 5x6-8L



SYMBOLS	MILLIMETERS		
	MIN	NOM	MAX
A	0.85	0.95	1.00
A1	0.00	—	0.05
b	0.30	0.40	0.50
c	0.15	0.20	0.25
D	5.20 BSC		
D1	4.35 BSC		
D2	0.50	0.60	0.75
E	5.55 BSC		
E1	6.05 BSC		
E2	3.82 BSC		
e	1.27 BSC		
L	0.45	0.55	0.65
L1	0.00	—	0.15
L2	0.68 REF		
θ	0°	—	10°

TOP MARKING DEFINITION

PDFN 5x6-8L

